COMPLIANT

HALOGEN

FREE



Vishay General Semiconductor

Fast Avalanche SMD Rectifier



SMA (DO-214AC)

| PRIMARY CHARACTERISTICS | | | | |
|-------------------------|----------------|--|--|--|
| I _{F(AV)} | 1.5 A | | | |
| V_{RRM} | 800 V, 1000 V | | | |
| I _{FSM} | 30 A | | | |
| I _R | 1.0 μΑ | | | |
| V_{F} | 1.6 V | | | |
| t _{rr} | 120 ns | | | |
| E _R | 20 mJ | | | |
| T _J max. | 150 °C | | | |
| Package | SMA (DO-214AC) | | | |
| Circuit configuration | Single | | | |

FEATURES

- Low profile package
- · Ideal for automated placement
- · Glass passivated pellet chip junction
- Low reverse current
- · Soft recovery characteristic
- Fast reverse recovery time
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- AEC-Q101 qualified available
 - Automotive ordering code P/NHE3 or P/NHM3
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

TYPICAL APPLICATIONS

For use in fast switching rectification of power supply, inverters, converters, and freewheeling diodes for consumer, automotive, and telecommunication.

MECHANICAL DATA

Case: SMA (DO-214AC)

Molding compound meets UL 94 V-0 flammability rating Base P/N-E3 - RoHS-compliant, commercial grade

Base P/N-M3 - halogen-free, RoHS-compliant, and

commercial grade

Base P/NHE3_X - RoHS-compliant, and AEC-Q101

qualified

Base P/NHM3_X - halogen-free, RoHS-compliant and

AEC-Q101 qualified

("_X" denotes revision code e.g. A, B,...)

Terminals: matte tin plated leads, solderable per J-STD-002 and JESD 22-B102

E3, M3, HE3, and HM3 suffix meet JESD 201 class 2 whisker test

Polarity: color band denotes the cathode end

| MAXIMUM RATINGS (T _A = 25 °C unless otherwise noted) | | | | | |
|-----------------------------------------------------------------------------------------------------------------------------|-----------------------------------|-------------|--------|------|--|
| PARAMETER | SYMBOL | BYG21K | BYG21M | UNIT | |
| Device marking code | | BYG21K | BYG21M | | |
| Maximum repetitive peak reverse voltage | V _{RRM} | 800 | 1000 | V | |
| Average forward current | I _{F(AV)} | 1.5 | | Α | |
| Peak forward surge current 10 ms single half sine-wave superimposed on rated load | I _{FSM} | 30 | | А | |
| Pulse energy in avalanche mode, non repetitive (inductive load switch off) I _{(BR)R} = 1 A, T _J = 25 °C | E _R | 20 | | mJ | |
| Operating junction and storage temperature range | T _J , T _{STG} | -55 to +150 | | °C | |



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| ELECTRICAL CHARACTERISTICS (T _A = 25 °C unless otherwise noted) | | | | | | |
|-----------------------------------------------------------------------------------|-----------------------------------------------------------------------------|-----------------------------------|-----------------|--------|--------|------|
| PARAMETER | TEST CONDITIONS | | SYMBOL | BYG21K | BYG21M | UNIT |
| Maximum instantaneous | I _F = 1 A | $T_J = 25 ^{\circ}C$ $V_F^{(1)}$ | T _ 05 °C | 1. | 5 | V |
| forward voltage | I _F = 1.5 A | | v F (.,) | 1. | 6 | v |
| Maximum reverse current | V V | T _J = 25 °C | I _R | 1 | | |
| | $V_R = V_{RRM}$ T | T _J = 100 °C | | 10 | | μA |
| Maximum reverse recovery time | I _F = 0.5 A, I _R = 1.0 A, I _{rr} = 0.25 A | | t _{rr} | 120 | | ns |

Note

 $^{(1)}$ Pulse test: 300 μs pulse width, 1 % duty cycle

| THERMAL CHARACTERISTICS (T _A = 25 °C unless otherwise noted) | | | | | |
|-------------------------------------------------------------------------|---------------------------------|--------|--------|------|--|
| PARAMETER | SYMBOL | BYG21K | BYG21M | UNIT | |
| Typical thermal resistance, junction to lead, T _L = const. | $R_{\theta JL}$ | 25 | | °C/W | |
| Typical thermal resistance, junction to ambient | R _{θJA} ⁽¹⁾ | 150 | | | |
| | R ₀ JA (2) | 125 | | °C/W | |
| | R _{0JA} (3) | 100 |) | | |

Notes

- (1) Mounted on epoxy-glass hard tissue
- (2) Mounted on epoxy-glass hard tissue, 50 mm² 35 μm Cu
- (3) Mounted on Al-oxide-ceramic (Al₂O₃), 50 mm² 35 µm Cu

| ORDERING INFORMATION (Example) | | | | | |
|--------------------------------|-----------------|------------------------|---------------|------------------------------------|--|
| PREFERRED P/N | UNIT WEIGHT (g) | PREFERRED PACKAGE CODE | BASE QUANTITY | DELIVERY MODE | |
| BYG21K-E3/TR | 0.064 | TR | 1800 | 7" diameter plastic tape and reel | |
| BYG21K-E3/TR3 | 0.064 | TR3 | 7500 | 13" diameter plastic tape and reel | |
| BYG21KHE3_A/H (1) | 0.064 | Н | 1800 | 7" diameter plastic tape and reel | |
| BYG21KHE3_A/I (1) | 0.064 | I | 7500 | 13" diameter plastic tape and reel | |
| BYG21K-M3/TR | 0.064 | TR | 1800 | 7" diameter plastic tape and reel | |
| BYG21K-M3/TR3 | 0.064 | TR3 | 7500 | 13" diameter plastic tape and reel | |
| BYG21KHM3_A/H (1) | 0.064 | Н | 1800 | 7" diameter plastic tape and reel | |
| BYG21KHM3_A/I (1) | 0.064 | I | 7500 | 13" diameter plastic tape and reel | |

Note

RATINGS AND CHARACTERISTICS CURVES (T_A = 25 °C unless otherwise noted)

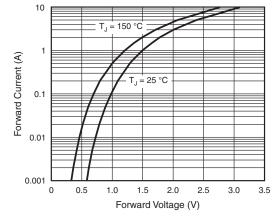


Fig. 1 - Forward Current vs. Forward Voltage

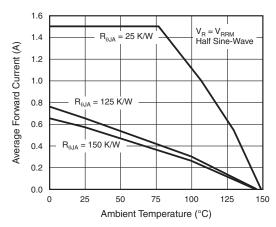


Fig. 2 - Max. Average Forward Current vs. Ambient Temperature

⁽¹⁾ AEC-Q101 qualified



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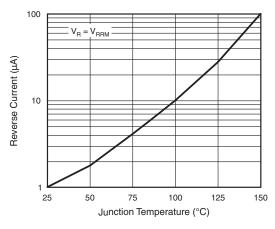


Fig. 3 - Reverse Current vs. Junction Temperature

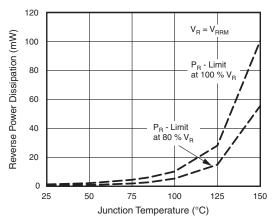


Fig. 4 - Max. Reverse Power Dissipation vs. Junction Temperature

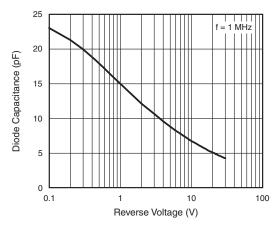


Fig. 5 - Diode Capacitance vs. Reverse Voltage

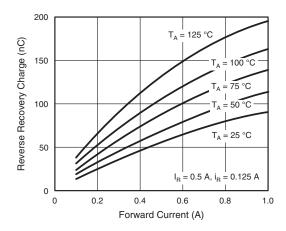


Fig. 6 - Max. Reverse Recovery Charge vs. Forward Current

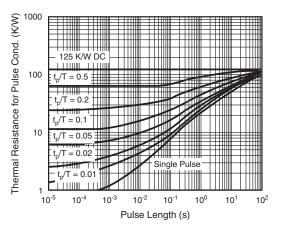


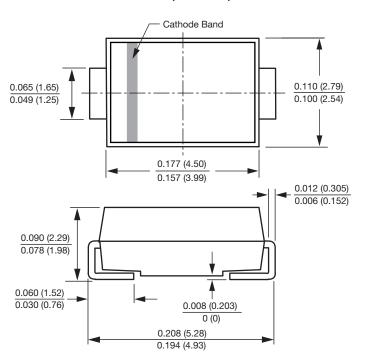
Fig. 7 - Thermal Response

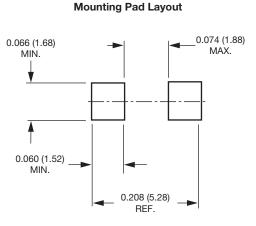


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PACKAGE OUTLINE DIMENSIONS in inches (millimeters)

SMA (DO-214AC)







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